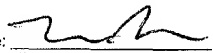




I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on the date shown below.

Dated: January 28, 2003

Signature:   
(Marcus J. Millet)

Docket No.: TESSERA 3.0-102 II DIV  
(PATENT)

2827

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Thomas H. DiStefano

Serial No.: 09/628,049

Group Art Unit: 2827

Filed: July 27, 2000

Examiner: D. Graybill

For: PACKAGED MICROELECTRONIC  
ELEMENTS WITH ENHANCED THERMAL  
CONDUCTION

**LETTER TO OFFICIAL DRAFTSMAN**

Commissioner for Patents  
Washington, DC 20231

Dear Sir:

Subject to approval of the Examiner, please substitute the seven (7) sheets of formal drawings enclosed herewith for the informal drawings presently on file. The formal drawings further respond to the objections set forth in the Official Action mailed August 28, 2002 by incorporating the changes set forth in applicant's Amendment dated December 30, 2002, filed in response to said Official Action.

In the event there are any fees due or owing in connection with this matter, please charge same to our Deposit Account No. 12-1095.

Dated: January 28, 2003

Respectfully submitted,

By 

Marcus J. Millet  
Registration No.: 28,241  
LERNER, DAVID, LITTENBERG,  
KRUMHOLZ & MENTLIK, LLP  
600 South Avenue West  
Westfield, New Jersey 07090  
(908) 654-5000  
Attorneys for Applicant

411951\_1.DOC

RECEIVED  
FEB - 7 2003  
TECHNOLOGY CENTER 2800